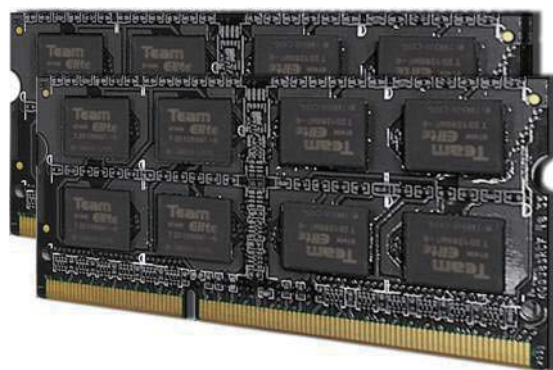




Module | Elite Series

Team Elite (DDR3 1866/1600/1333/1066)

Team launches the latest ELITE DDR3 dual channel module kit. In addition to delivering the super capacity of 16GB (2x8GB), it is faster (DDR3-1866) and has better performance (maximum computing speed up to 14,900 MHz). Additionally, PCs respond faster and smoother when using high-capacity memory modules in dual-channel configuration. The ELITE DDR3 from Team is characterized by its high speed, low power consumption, and high efficiency features. More importantly, it is compatible with various motherboards using various chipsets on the market.

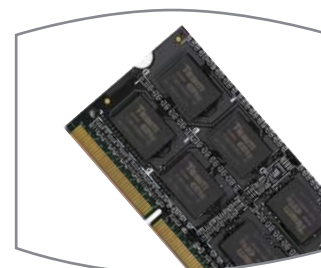


Main Feature

- ☐ Larger capacity: 16GB Kit (8GBx2)
- ☐ Faster speed: DDR3-1866
- ☐ Greater performance: Maximum computing speed up to 14,900MHz
- ☐ Energy saving: 1.5V

Specification

Item	Specification
TYPE	Laptop
Module specification	204Pin SO-DIMM Non ECC
DRAM Configuration	256x8 , 512x8
Capacity	2GB / 2GBx2 / 4GB / 4GBx2 / 8GB / 8GBx2
	8,528 MB / Sec (PC3 8500)
Data transfer bandwidth	10,664 MB / Sec (PC3 10600)
	12,800 MB / Sec (PC3 12800)
	14,900 MB / Sec (PC3 14900)
CL-value	CL7-7-7-21
	CL9-9-9-24
	CL11-11-11-28
	CL13-13-13-32
Working voltage	1.5V
PCB	6 / 8-layer PCB
Warranty	Lifetime Warranty



Ordering Information

Single Channel Kit

Team P/N	Capacity	Description
TED32G1066C7-S01	2GB	DDR3 1066MHz CL7-7-7-21 2GB 1.5V
TED32GM1066C7-S01	2GB	DDR3 1066MHz CL7-7-7-21 2GB 1.5V
TED34G1066C7-S01	4GB	DDR3 1066MHz CL7-7-7-21 4GB 1.5V
TED34GM1066C7-S01	4GB	DDR3 1066MHz CL7-7-7-21 4GB 1.5V
TED32G1333C9-S01	2GB	DDR3 1333MHz CL9-9-9-24 2GB 1.5V
TED32GM1333C9-S01	2GB	DDR3 1333MHz CL9-9-9-24 2GB 1.5V
TED34G1333C9-S01	4GB	DDR3 1333MHz CL9-9-9-24 4GB 1.5V
TED34GM1333C9-S01	4GB	DDR3 1333MHz CL9-9-9-24 4GB 1.5V
TED38G1333C9-S01	8GB	DDR3 1333MHz CL9-9-9-24 8GB 1.5V
TED38GM1333C9-S01	8GB	DDR3 1333MHz CL9-9-9-24 8GB 1.5V



Ordering Information

Single Channel Kit

Team P/N	Capacity	Description
TED32G1600C11-S01	2GB	DDR3 1600MHz CL11-11-11-28 2GB 1.5V
TED32GM1600C11-S01	2GB	DDR3 1600MHz CL11-11-11-28 2GB 1.5V
TED34G1600C11-S01	4GB	DDR3 1600MHz CL11-11-11-28 4GB 1.5V
TED34GM1600C11-S01	4GB	DDR3 1600MHz CL11-11-11-28 4GB 1.5V
TED38G1600C11-S01	8GB	DDR3 1600MHz CL11-11-11-28 8GB 1.5V
TED38GM1600C11-S01	8GB	DDR3 1600MHz CL11-11-11-28 8GB 1.5V
TED34G1866C13-S01	4GB	DDR3 1866MHz CL13-13-13-32 4GB 1.5V
TED34GM1866C13-S01	4GB	DDR3 1866MHz CL13-13-13-32 4GB 1.5V
TED38G1866C13-S01	8GB	DDR3 1866MHz CL13-13-13-32 8GB 1.5V
TED38GM1866C13-S01	8GB	DDR3 1866MHz CL13-13-13-32 8GB 1.5V

Dual Channel Kit

TED34G1066C7DC-S01	2GBx2	DDR3 1066MHz CL7-7-7-21 2GBx2 1.5V
TED34GM1066C7DC-S01	2GBx2	DDR3 1066MHz CL7-7-7-21 2GBx2 1.5V
TED38G1066C7DC-S01	4GBx2	DDR3 1066MHz CL7-7-7-21 4GBx2 1.5V
TED38GM1066C7DC-S01	4GBx2	DDR3 1066MHz CL7-7-7-21 4GBx2 1.5V
TED34G1333C9DC-S01	2GBx2	DDR3 1333MHz CL9-9-9-24 2GBx2 1.5V
TED34GM1333C9DC-S01	2GBx2	DDR3 1333MHz CL9-9-9-24 2GBx2 1.5V
TED38G1333C9DC-S01	4GBx2	DDR3 1333MHz CL9-9-9-24 4GBx2 1.5V
TED38GM1333C9DC-S01	4GBx2	DDR3 1333MHz CL9-9-9-24 4GBx2 1.5V
TED316G1333C9DC-S01	8GBx2	DDR3 1333MHz CL9-9-9-24 8GBx2 1.5V
TED316GM1333C9DC-S01	8GBx2	DDR3 1333MHz CL9-9-9-24 8GBx2 1.5V
TED34G1600C11DC-S01	2GBx2	DDR3 1600MHz CL11-11-11-28 2GBx2 1.5V
TED34GM1600C11DC-S01	2GBx2	DDR3 1600MHz CL11-11-11-28 2GBx2 1.5V
TED38G1600C11DC-S01	4GBx2	DDR3 1600MHz CL11-11-11-28 4GBx2 1.5V
TED38GM1600C11DC-S01	4GBx2	DDR3 1600MHz CL11-11-11-28 4GBx2 1.5V
TED316G1600C11DC-S01	8GBx2	DDR3 1600MHz CL11-11-11-28 8GBx2 1.5V
TED316GM1600C11DC-S01	8GBx2	DDR3 1600MHz CL11-11-11-28 8GBx2 1.5V
TED38G1866C13DC-S01	4GBx2	DDR3 1866MHz CL13-13-13-32 4GBx2 1.5V
TED38GM1866C13DC-S01	4GBx2	DDR3 1866MHz CL13-13-13-32 4GBx2 1.5V
TED316G1866C13DC-S01	8GBx2	DDR3 1866MHz CL13-13-13-32 8GBx2 1.5V
TED316GM1866C13DC-S01	8GBx2	DDR3 1866MHz CL13-13-13-32 8GBx2 1.5V

Above technical information is based on industry standard data and tested to be reliable. However, Team makes no warranty, either expressed or implied, as to its accuracy and assumes no liability in connection with the use of this product.

Team reserves the right to make changes in specifications at any time without prior notice.